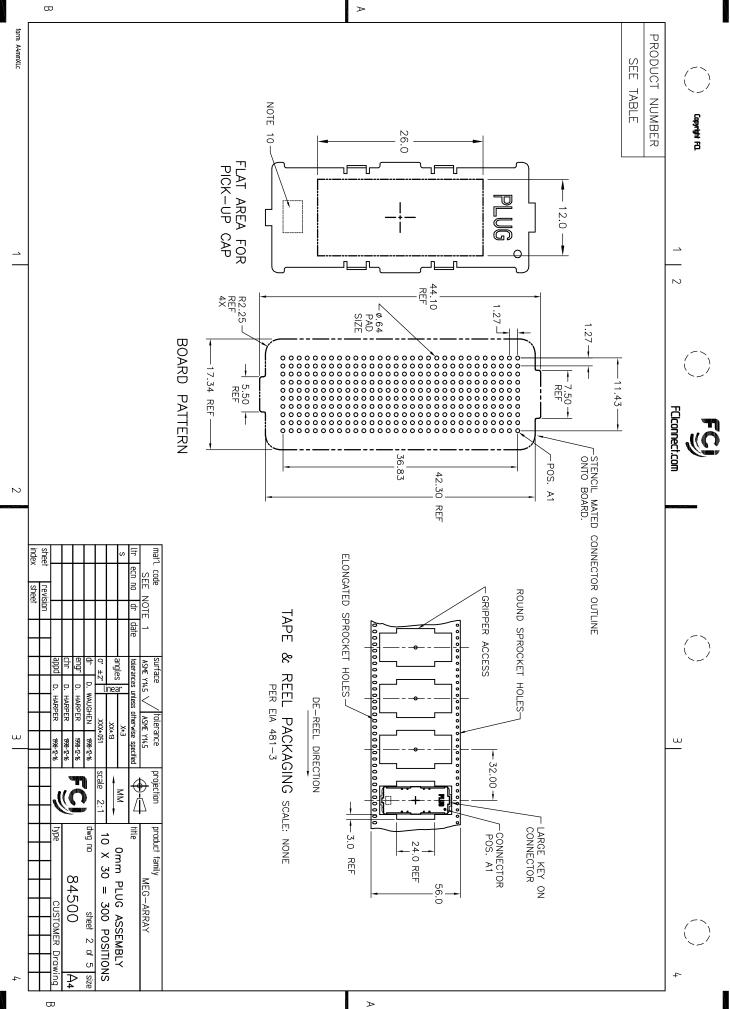


PDS: Rev :S

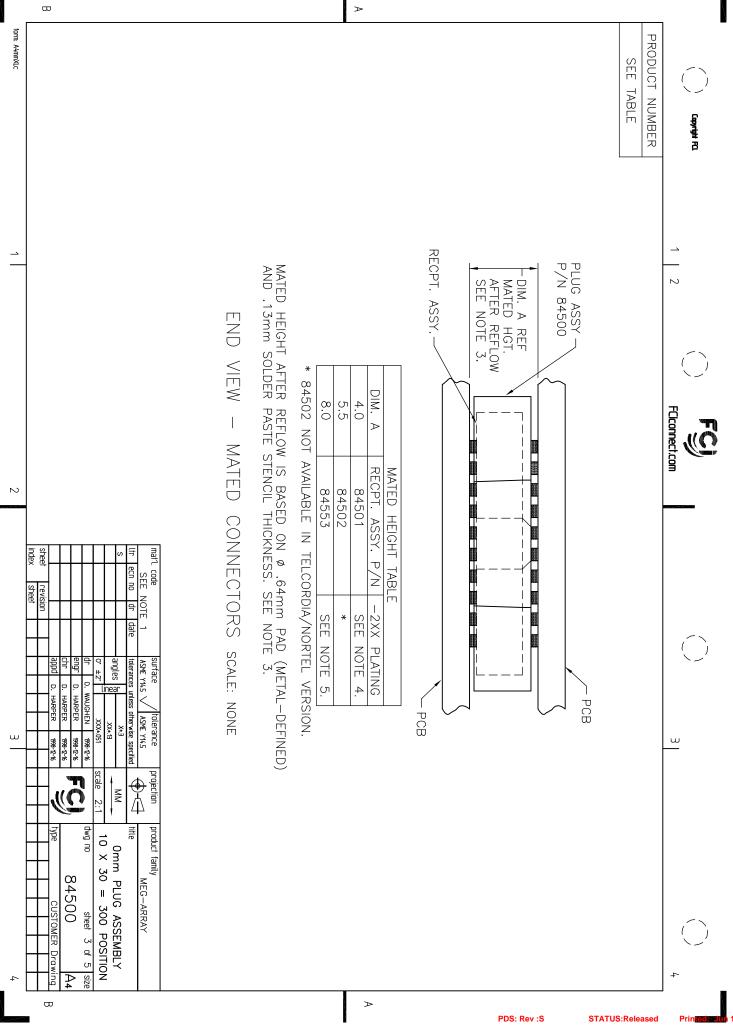
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|--|---|----------------|
| 84500-002LF 84500-092LF 84500-092LF 84500-093 84500-102 84500-102LF 84500-192LF 84500-202LF 84500-202LF 84500-292LF 84500-292LF 84500-292LF 84500-A02LF 84500-A02LF | PRODUCT NUMBER | |
| YES YES WITH VENT HOLES YES YES YES YES YES YES YES YES YES Y | PICK-UP CAP (NATURAL OR BLACK IN COLOR) | |
| 15µ" (.38µm) Au 15µ" (.38µm) GXT 30µ" (.76µm) GXT 30µ" (.76µm) GXT 50µ" (.76µm) Au 50µ" (.76µm) GXT 50µ" (.76µm) GXT SPECIAL 50µ" (1.27µm) GXT SPECIAL 50µ" (.76µm) 30µ" (.76µm) GXT SPECIAL 50µ" (.76µm) 30µ" (.76µm) S0µ" (.76µm) S0µ" (.76µm) S0µ" (.76µm) S0µ" (.76µm) S0µ" (.76µm) GXT SPECIAL 50µ" (.76µm) S0µ" (.76µm) GXT SPECIAL 50µ" (.76µm) steel | | FCIconnect.com |
| code SnPb LEAD FREE SnPb LEAD FREE SnPb LEAD FREE SnPb LEAD FREE SnPb LEAD FREE SnPb LEAD FREE SnPb LEAD FREE SnPb LEAD FREE SnPb LEAD FREE SnPb LEAD FREE SnPb SnPb LEAD FREE SnPb SnPb SnPb SnPb Code SnPb | SOLDER BALL | \bigcirc |
| Image: State 2:1 Image: State 2:1< | NOTES | |
| utf family MEG-ARRAY Omm PLUG ASSEMBLY X 30 = 300 POSITIONS B 4500 CUSTOMER Drawing 4 4 | | 4 |

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| B 1 2 | NOTES: (1) MATERIAL: HOUSING: LOP CONTACT: COPPER ALLOY PLATING: CONTACT: SEE TABLE) SOLDER BALLS WILL NOT BE PERFECT SPHERICAL SHAPE (2) SOLDER BALLS WILL NOT BE PERFECT SPHERICAL SHAPE DUE TO REFLOW ATTACHMENT. (3) MATED HEIGHT EFFECTED BY CUSTOMER'S PCB PAD SIZE, PLATING, SOLDER REFLOW PROFILE, & SOLDER PASTE. (4) PLATING FOR INDICATED -22X SERIES PRODUCT NUMBERS MEET THE REQUIREMENTS OF (GR-1217-CORE, CENTRAL OFFICE ENVIRONMENT, 25 YEAR LIFE EXPECTANCY). (5) PLATING FOR INDICATED -2XX SERIES PART NOS. IS AU OVER NI WITH SPECIAL CONTACT GEOMETRY TO MEET REQUIREMENTS OF TELCORDIA GR-1217-CORE: CENTRAL OFFICE ENVIRONMENT. (6) KNIT LINE: SLIGHT VISIBLE MARKS (USUALLY A LINE) INDICATING THE DIRECTION AND MEETING POINT OF PLASTIC RESIN FLOW FRONTS TRAVELING AROUND ANY OBSTRUCTIONS TO THE RESIN FLOW VIA THE REQUIRED MOLD TOOLING. | Converter PRODUCT NUMBER SEE TABLE |
|---|--|--|
| mal't. code surface Inderance projection product family SEE NOTE 1 Asve YHS Asve YHS Image: Second and angles Image: Second angles | (7) FOR PROPER APPLICATION FOLLOW FCI APPLICATION SPECIFICATION CS-20-033 LEAD FREE SOLDER BALLS WILL NOT SOLDER PROPERTY IN A LEADED SOLDER PROCESS DUE TO A HIGHER REFLOW TEMPERATURE. LEAD FREE PRODUCT IS THEREFORE NOT BACKWARDS COMPATIBLE WITH LEADED OR SOME SOLDERING APPLICATIONS. REFERENCE FCI APPLICATION SPECIFICATION. (8) THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND PRODUCT MEETING THIS DIRECTIVE IS IDENTIFIED IN STHE LOT CODE NUMBER MARKED ON EACH PART BY HAVING AN "X" IN THE SEVENTH CHARACTER POSITION. (9) 84500-A02 AND -A02LF ARE CUSTOMER SPECIALS. (10) CURRENT COMPANY LOGO TO BE VISIBLE IN APPROXIMATE AREA SHOWN. 11. A SYMBOL WILL BE NEXT TO ANY DIMENSION, NEW VIEW OR NOTE WHICH HAS BEEN MODIFIED WITH THE CURRENT DRAWING REVISION | Ε Ε 4 |

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